



## Precision Automotive High Voltage Thin Film MELF Resistors



### FEATURES

- High operating voltage,  $U_{max.} = 1200\text{ V}$
- AEC-Q200 qualified
- Advanced metal film technology
- Intrinsic sulfur resistance
- Material categorization:  
for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### LINKS TO ADDITIONAL RESOURCES



MMA 0204 HV AT and MMB 0207 HV AT precision thin film MELF resistors are the perfect choice for most fields of modern professional electronics where reliability and stability is of major concern. The typical applications in the fields of automotive, lighting, industrial, and medical equipment reflect the outstanding level of proven reliability.

### APPLICATIONS

- Automotive
- Lighting
- Industrial
- Medical equipment

| TECHNICAL SPECIFICATIONS  |                              |                 |
|---|------------------------------|-----------------|
| DESCRIPTION   | MMA 0204 HV AT               | MMB 0207 HV AT  |
| DIN size  | 0204                         | 0207            |
| Metric size code  | RC3715M                      | RC6123M         |
| Resistance range  | 340 kΩ to 5.11 MΩ            | 340 kΩ to 10 MΩ |
| Resistance tolerance  | ± 0.5 %; ± 0.25 %; ± 0.1 %   |                 |
| Temperature coefficient   | ± 25 ppm/K                   |                 |
| Voltage coefficient  c  | < 1 ppm/V                    |                 |
| Rated dissipation, $P_{70}^{(1)}$                                     | 0.4 W                        | 1.0 W           |
| Operating voltage, $U_{max. AC_{RMS}/DC}$                             | 700 V                        | 1200 V          |
| Permissible film temperature, $\vartheta_{F max.}^{(1)}$              | 155 °C                       |                 |
| Operating temperature range <sup>(2)</sup>                            | -55 °C to 155 °C             |                 |
| Permissible voltage against ambient (insulation):<br>1 min, $U_{ins}$ | 300 V                        | 500 V           |
| Internal thermal resistance (typical) <sup>(1)</sup>                  | 46 K/W                       | 26 K/W          |
| Failure rate: FIT <sub>observed</sub>                                 | ≤ 0.05 x 10 <sup>-9</sup> /h |                 |

#### Notes

- <sup>(1)</sup> Please refer to APPLICATION INFORMATION below  
<sup>(2)</sup> Please refer to table TEST PROCEDURES AND REQUIREMENTS, see below

### APPLICATION INFORMATION

When the resistor dissipates power, a temperature rise above the ambient temperature occurs, dependent on the thermal resistance of the assembled resistor together with the printed circuit board. The rated dissipation applies only if the permitted film temperature is not exceeded.

Please consider the application note “Thermal Management in Surface-Mounted Resistor Applications” ([www.vishay.com/doc?28844](http://www.vishay.com/doc?28844)) for information on the general nature of thermal resistance.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.



| MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION                                 |                |                                   |                                   |
|--|----------------|-----------------------------------|-----------------------------------|
| OPERATION MODE   |                | STANDARD                          | POWER                             |
| Rated dissipation, $P_{70}$  | MMA 0204 HV AT | 0.25 W                            | 0.4 W                             |
|  | MMB 0207 HV AT | 0.4 W                             | 1.0 W                             |
| Operating temperature range  |                | -55 °C to 125 °C                  | -55 °C to 155 °C                  |
| Permissible film temperature, $\vartheta_F$ max.                               |                | 125 °C                            | 155 °C                            |
| Max. resistance change at $P_{70}$ for resistance range, $ \Delta R/R $ after: | MMA 0204 HV AT | 340 k $\Omega$ to 5.11 M $\Omega$ | 340 k $\Omega$ to 5.11 M $\Omega$ |
|  | MMB 0207 HV AT | 340 k $\Omega$ to 10 M $\Omega$   | 340 k $\Omega$ to 10 M $\Omega$   |
|  | 1000 h         | $\leq 0.25 \%$                    | $\leq 0.5 \%$                     |
|  | 8000 h         | $\leq 0.5 \%$                     | $\leq 1 \%$                       |
|  | 225 000 h      | $\leq 1.5 \%$                     | $\leq 3 \%$                       |

**Note**

- The presented operation modes do not refer to different types of resistors, but actually show examples of different loads, that lead to different film temperatures and different achievable load-life stability (drift) of the resistance value. A suitable low thermal resistance of the circuit board assembly must be safeguarded in order to maintain the film temperature of the resistors within the specified limits. Please consider the application note "Thermal Management in Surface-Mounted Resistor Applications" ([www.vishay.com/doc?28844](http://www.vishay.com/doc?28844)) for information on the general nature of thermal resistance

| TEMPERATURE COEFFICIENT AND RESISTANCE RANGE |                |               |                                   |           |
|--|----------------|---------------|-----------------------------------|-----------|
| TYPE / SIZE                                  | TCR            | TOLERANCE     | RESISTANCE                        | E-SERIES  |
| MMA 0204 HV AT                               | $\pm 25$ ppm/K | $\pm 0.5 \%$  | 340 k $\Omega$ to 5.11 M $\Omega$ | E24; E192 |
|  |                | $\pm 0.25 \%$ |                                   |           |
|  |                | $\pm 0.1 \%$  |                                   |           |
| MMB 0207 HV AT                               | $\pm 25$ ppm/K | $\pm 0.5 \%$  | 340 k $\Omega$ to 10 M $\Omega$   | E24; E192 |
|  |                | $\pm 0.25 \%$ |                                   |           |
|  |                | $\pm 0.1 \%$  |                                   |           |

| PACKAGING      |         |          |   |       |       |                            |
|----------------|---------|----------|---|-------|-------|----------------------------|
| TYPE / SIZE    | CODE    | QUANTITY | PACKAGING STYLE                                   | WIDTH | PITCH | PACKAGING DIMENSIONS       |
| MMA 0204 HV AT | B3 = BL | 3000     | Antistatic blister tape acc. IEC 60286-3, Type 2a | 8 mm  | 4 mm  | $\varnothing$ 180 mm / 7"  |
|                | B0      | 10 000   |   |       |       | $\varnothing$ 330 mm / 13" |
| MMB 0207 HV AT | B2      | 2000     |   | 12 mm |       | $\varnothing$ 180 mm / 7"  |
|                | B7      | 7000     |   |       |       | $\varnothing$ 330 mm / 13" |



| PART NUMBER AND PRODUCT DESCRIPTION                  |              |            |                                |                             |                      |               |   |   |   |   |   |  |   |                      |   |   |   |
|--|--------------|------------|--------------------------------|-----------------------------|----------------------|---------------|---|---|---|---|---|--|---|----------------------|---|---|---|
| Part Number: MMA0204SD5623BB300                      |              |            |                                |                             |                      |               |   |   |   |   |   |  |   |                      |   |   |   |
| M  | M            | A          | 0                              | 2                           | 0                    | 4             | S | D   | 5 | 6 | 2 | 3  | B | B                    | 3 | 0 | 0 |
| TYPE / SIZE  |              | VERSION    |                                |                             | TCR                  |               |   | RESISTANCE  |   |   |   | TOLERANCE                                  |   | PACKAGING            |   |   |   |
| MMA0204<br>MMB0207                                   |              | S = HV AT  |                                |                             | D = ± 25 ppm/K       |               |   | 3 digit value<br>1 digit multiplier<br><br>Multiplier<br>3 = *10 <sup>3</sup><br>4 = *10 <sup>4</sup><br>5 = *10 <sup>5</sup> |   |   |   | B = ± 0.1 %<br>C = ± 0.25 %<br>D = ± 0.5 % |   | B2<br>B3<br>B7<br>B0 |   |   |   |
| Product Description: MMA 0204-25 0.1 % HV AT BL 562K |              |            |                                |                             |                      |               |   |   |   |   |   |  |   |                      |   |   |   |
| MMA  | 0204         | -25        | 0.1 %                          | S                           | BL                   | 562K          |   |   |   |   |   |  |   |                      |   |   |   |
| TYPE   | SIZE         | TCR        | TOLERANCE                      | HIGH VOLTAGE,<br>AUTOMOTIVE | PACKAGING            | RESISTANCE    |   |   |   |   |   |  |   |                      |   |   |   |
| MMA<br>MMB   | 0204<br>0207 | ± 25 ppm/K | ± 0.1 %<br>± 0.25 %<br>± 0.5 % |                             | B2<br>BL<br>B7<br>B0 | 562K = 562 kΩ |   |   |   |   |   |  |   |                      |   |   |   |

**Note**

- Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION



## DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade ceramic body (Al<sub>2</sub>O<sub>3</sub>) and conditioned to achieve the desired temperature coefficient. Nickel plated steel termination caps are firmly pressed on the metallised rods. A special laser is used to achieve the target value by smoothly cutting a helical groove in the resistive layer without damaging the ceramics. The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure matte tin on nickel plating. Four (E24), respectively five (E192) color code rings designate the resistance value and tolerance in accordance with **IEC 60062** <sup>(1)</sup>.

The result of the determined production is verified by an extensive testing procedure performed on 100 % of the individual resistors. This includes full screening for the elimination of products with a potential risk of early life failures according to EN 140401-803, 2.1.2.2. Only accepted products are laid directly into the blister tape in accordance with **IEC 60286-3, Type 2a** <sup>(1)</sup>.

## ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapor phase as shown in **IEC 61760-1** <sup>(1)</sup>. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, potting compounds and their processes, if applied, shall be qualified by appropriate means to ensure the long term stability of the whole system.

The resistors are completely lead (Pb)-free, the pure matte tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes. Solderability is specified for 2 years after production or requalification, however, excellent solderability is proven after extended storage in excess of 10 years. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

## Notes

- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents
- (2) The IEC 62474 list of declarable substances is maintained in a dedicated database, which is available at <http://std.iec.ch/iec62474>
- (3) The Global Automotive Declarable Substance List (GADSL) is maintained by the American Chemistry Council and available at [www.gadsl.org](http://www.gadsl.org)
- (4) The SVHC list is maintained by the European Chemical Agency (ECHA) and available at <http://echa.europa.eu/candidate-list-table>

## MATERIALS

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein <sup>(2)</sup>
- The Global Automotive Declarable Substance List (GADSL) <sup>(3)</sup>
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) <sup>(4)</sup> for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see [www.vishay.com/how/leadfree](http://www.vishay.com/how/leadfree).

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at [www.vishay.com/doc?49037](http://www.vishay.com/doc?49037).

## APPROVALS

Where applicable, the resistors are tested in accordance with **EN 140401-803** which refers to **EN 60115-1, EN 60115-8** and the variety of environmental test procedure of the **IEC 60068** <sup>(1)</sup> series.

Vishay Beyschlag has achieved “**Approval of Manufacturer**” in accordance with **IECQ 03-1**. The release certificate for “**Technology Approval Schedule**” in accordance with **CECC 240001** based on **IECQ 03-3-1** is granted for the Vishay Beyschlag manufacturing process. The resistors are qualified according to AEC-Q200.

## RELATED PRODUCTS

For thin film products with a wider resistance, see the datasheet:

- “Professional Thin Film MELF Resistors”  
([www.vishay.com/doc?28713](http://www.vishay.com/doc?28713))

For products with tighter precision specification, see the datasheet:

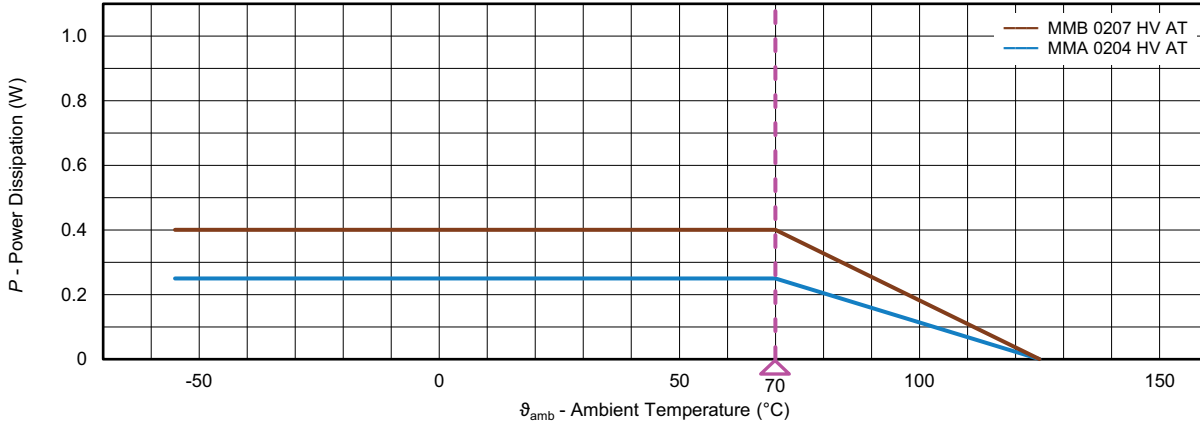
- “Precision Thin Film MELF Resistors”  
([www.vishay.com/doc?28714](http://www.vishay.com/doc?28714))

For high voltage products with focus on industrial applications see the datasheet:

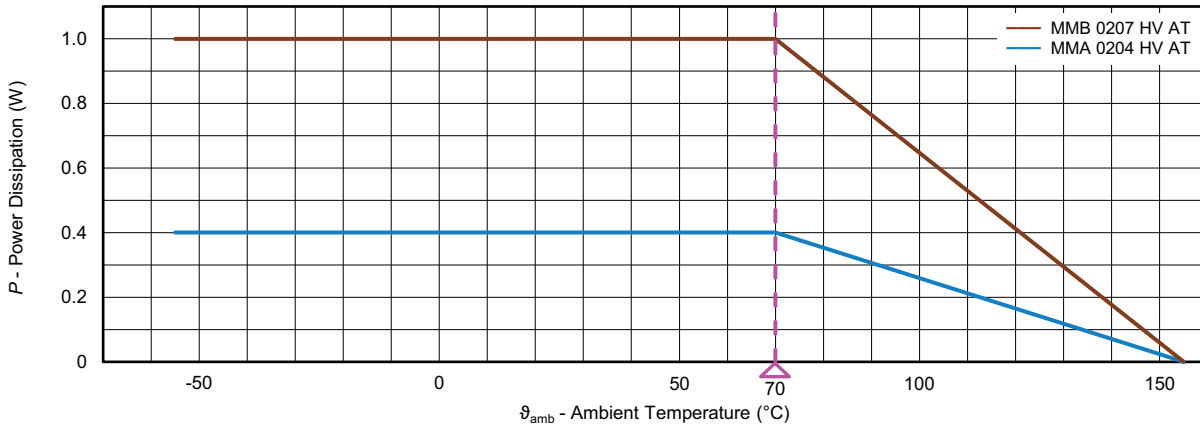
- “Professional Thin Film High Voltage MELF Resistors”  
([www.vishay.com/doc?28880](http://www.vishay.com/doc?28880))



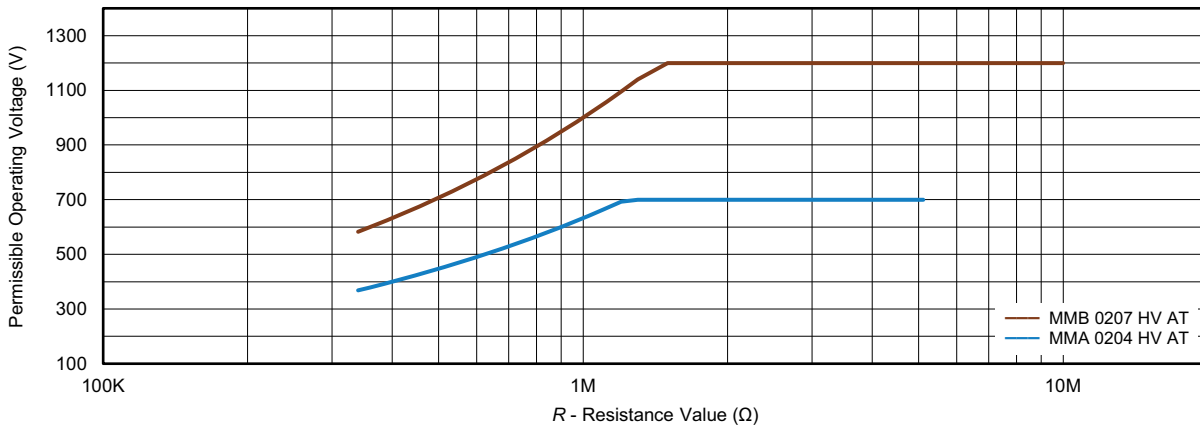
## FUNCTIONAL PERFORMANCE



### Derating - Standard Operation Mode

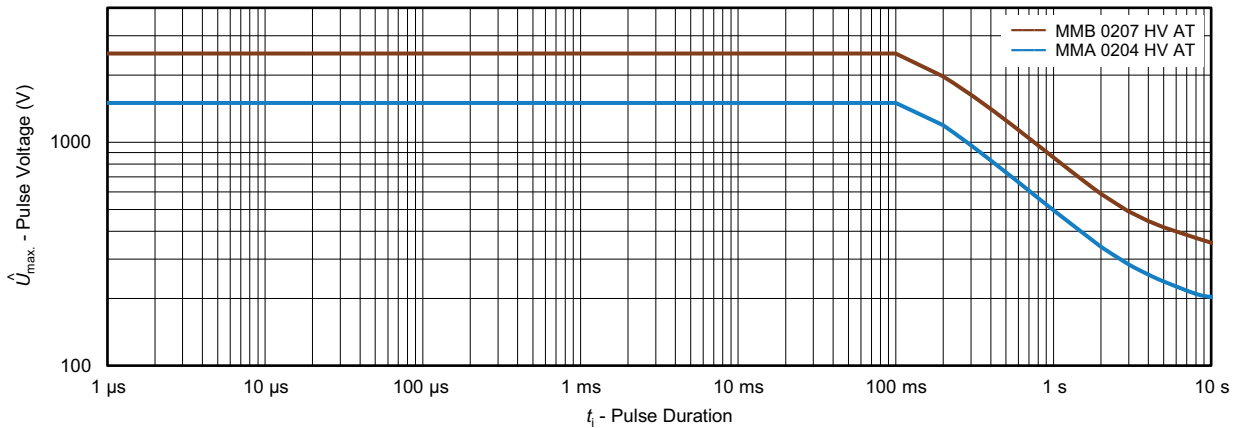


### Derating - Power Operation Mode



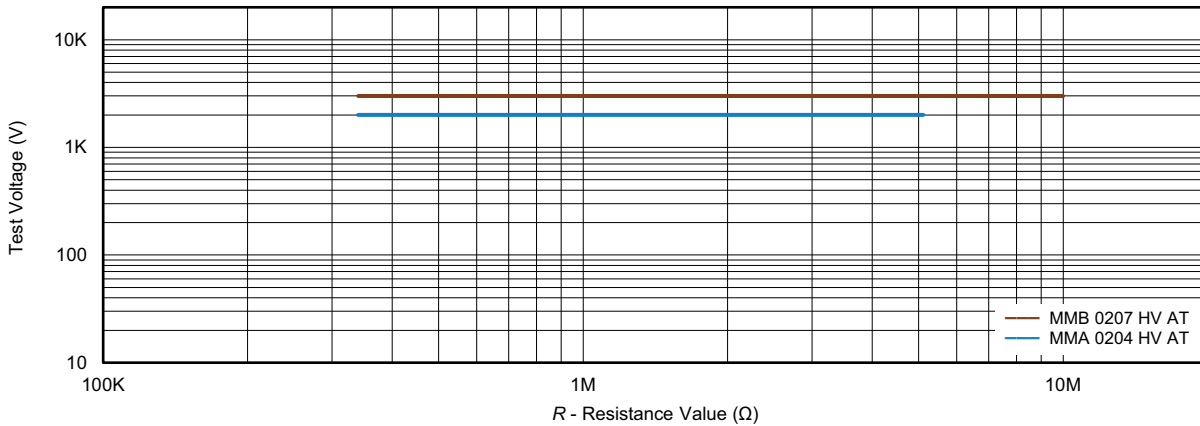
The permissible operating voltage equals the rated voltage  $U_R = \sqrt{P_{70} \times R}$ .  
 For ambient temperatures above 70 °C power derating must be considered

### Nominal Operating Voltage



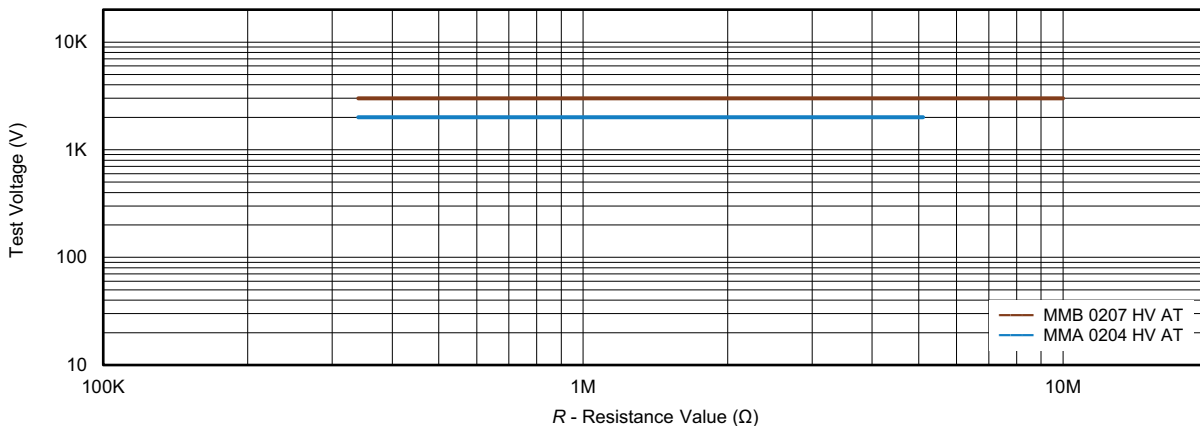
Maximum pulse voltage, single and continuous pulses; applicable if  $\hat{P} \leq \hat{P}_{max}$ ; for permissible resistance change  $\pm (0.5 \% R + 0.01 \Omega)$

### Pulse Voltage



Pulse load rating in accordance with IEC 60115-1, 8.2; 1.2  $\mu$ s/50  $\mu$ s; 5 pulses at 12 s intervals; for permissible resistance change  $\pm (0.5 \% R + 0.05 \Omega)$

### 1.2/50 Pulse



Pulse load rating in accordance with IEC 60115-1, 8.2; 10  $\mu$ s/700  $\mu$ s; 10 pulses at 1 minute intervals; for permissible resistance change  $\pm (0.5 \% R + 0.05 \Omega)$

### 10/700 Pulse



**TESTS AND REQUIREMENTS**

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 60115-8, sectional specification
- EN 140401-803, detail specification
- IEC 60068-2-xx, test methods

The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-803. The table presents only the most important tests, for the full test schedule refer to the documents listed above. However, some additional tests and a number of improvements against those minimum requirements have been included.

The testing also covers most of the requirements specified by EIA/ECA-703 and JIS-C-5201-1.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3, whereupon the following values are applied:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25 % to 75 %
- Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar)

A climatic category LCT / UCT / 56 is applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the duration of exposure in the damp heat, steady state test (56 days).

The components are mounted for testing on printed circuit boards in accordance with EN 60115-8, 2.4.2, unless otherwise specified.

| TEST PROCEDURES AND REQUIREMENTS |                                   |  |   |   |                                    |
|----------------------------------|-----------------------------------|--|---|---|------------------------------------|
| EN 60115-1<br>CLAUSE             | IEC 60068-2 (1)<br>TEST<br>METHOD | TEST   | PROCEDURE   | REQUIREMENTS<br>PERMISSIBLE CHANGE ( $\Delta R$ ) |                                    |
|                                  |                                   |  |   | HIGH ACCURACY                                     | REGULAR ACCURACY                   |
|                                  |                                   |  | Stability for product types:  |   |                                    |
|                                  |                                   |  | <b>MMA 0204 HV AT</b>   | 340 k $\Omega$ to 1 M $\Omega$                    | 1.01 M $\Omega$ to 5.11 M $\Omega$ |
|                                  |                                   |  | <b>MMB 0207 HV AT</b>   | 340 k $\Omega$ to 1 M $\Omega$                    | 1.01 M $\Omega$ to 10 M $\Omega$   |
| 4.5                              | -                                 | Resistance   | -   | $\pm 0.5 \% R$ ; $\pm 0.25 \% R$ ; $\pm 0.1 \% R$ |                                    |
| 4.8                              | -                                 | Temperature coefficient                                    | At (20 / -55 / 20) °C and (20 / 155 / 20) °C  | $\pm 25$ ppm/K                                    |                                    |
| 4.25.1                           | -                                 | Endurance at 70 °C: standard operation mode                | $U = \sqrt{P_{70} \times R} \leq U_{max}$ ; whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h<br>70 °C; 8000 h   | $\pm (0.25 \% R)$<br>$\pm (0.5 \% R)$             |                                    |
|                                  |                                   | Endurance at 70 °C: power operation mode                   | $U = \sqrt{P_{70} \times R} \leq U_{max}$ ; whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h<br>70 °C; 8000 h   | $\pm (0.5 \% R)$<br>$\pm (1 \% R)$                |                                    |
| 4.25.3                           | -                                 | Endurance at upper category temperature                    | 125 °C; 1000 h  | $\pm (0.15 \% R)$                                 | $\pm (0.25 \% R)$                  |
|                                  |                                   |  | 155 °C; 1000 h  | $\pm (0.3 \% R)$                                  | $\pm (0.5 \% R)$                   |
| 4.24                             | 78 (Cab)                          | Damp heat, steady state                                    | (40 $\pm$ 2) °C; 56 days; (93 $\pm$ 3) % RH   | $\pm (0.15 \% R)$                                 | $\pm (0.25 \% R)$                  |
| -                                | -                                 | Damp heat, steady state, accelerated, power operation mode | (85 $\pm$ 2) °C; (85 $\pm$ 5) % RH; 1000 h; $U = \sqrt{0.1 \times P_r \times R_n}$ (for $U_r < 500$ V); $U = 0.1 \times \sqrt{P_r \times R_n}$ (for $U_r \geq 500$ V)<br>MMA 0204 HV AT:<br>MMB 0207 HV AT: | $\pm (0.25 \% R)$<br>$\pm (0.5 \% R)$             | $\pm (2 \% R)$<br>$\pm (2 \% R)$   |
| -                                | 1 (Ab)                            | Cold   | -55 °C; 2 h   | $\pm (0.02 \% R)$                                 |                                    |
| 4.19                             | 14 (Na)                           | Rapid change of temperature                                | 30 min at LCT; 30 min at UCT; LCT = -55 °C; UCT = 125 °C<br>1000 cycles   | $\pm (0.2 \% R)$                                  |                                    |

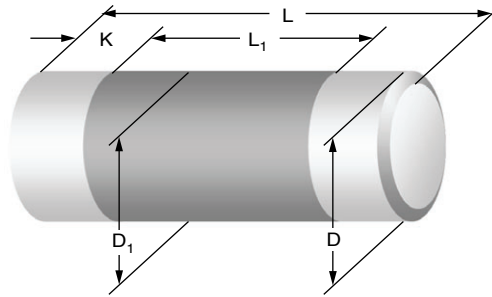


| TEST PROCEDURES AND REQUIREMENTS |                                   |   |  |  |                                    |
|----------------------------------|-----------------------------------|---|--|--|------------------------------------|
| EN 60115-1<br>CLAUSE             | IEC 60068-2 (1)<br>TEST<br>METHOD | TEST  | PROCEDURE  | REQUIREMENTS<br>PERMISSIBLE CHANGE ( $\Delta R$ )                        |                                    |
|                                  |                                   |   |  | HIGH ACCURACY  | REGULAR ACCURACY                   |
|                                  |                                   |   | Stability for product types:   |  |                                    |
|                                  |                                   |   | <b>MMA 0204 HV AT</b>  | 340 k $\Omega$ to 1 M $\Omega$   | 1.01 M $\Omega$ to 5.11 M $\Omega$ |
|                                  |                                   |   | <b>MMB 0207 HV AT</b>  | 340 k $\Omega$ to 1 M $\Omega$   | 1.01 M $\Omega$ to 10 M $\Omega$   |
| 4.13                             | -                                 | Short time overload: standard operation mode                | $U = 2.5 \times \sqrt{P_{70} \times R}$<br>$\leq 2 \times U_{max.}; 5 \text{ s}$   | $\pm (0.03 \% R)$  | $\pm (0.1 \% R)$                   |
|                                  |                                   | Short time overload: power operation mode                   |  | $\pm (0.05 \% R)$  | $\pm (0.15 \% R)$                  |
| 4.27                             | -                                 | Single pulse high voltage overload: standard operation mode | Severity no. 4:<br>$U = 10 \times \sqrt{P_{70} \times R}$<br>$\leq 2 \times U_{max.};$<br>10 pulses 10 $\mu\text{s}/700 \mu\text{s}$ | $\pm (0.1 \% R)$   | $\pm (0.25 \% R)$                  |
|                                  |                                   | Single pulse high voltage overload: power operation mode    |  | $\pm (0.2 \% R)$   | $\pm (0.5 \% R)$                   |
| 4.39                             | -                                 | Periodic electric overload: standard operation mode         | $U = \sqrt{15 \times P_{70} \times R}$<br>$\leq 2 \times U_{max.};$<br>0.1 s on; 2.5 s off;<br>1000 cycles                           | $\pm (0.1 \% R)$   | $\pm (0.5 \% R)$                   |
|                                  |                                   | Periodic electric overload: power operation mode            |  | $\pm (0.2 \% R)$   | $\pm (1.0 \% R)$                   |
| 4.22                             | 6 (Fc)                            | Vibration   | Endurance by sweeping;<br>10 Hz to 2000 Hz;<br>no resonance; amplitude<br>$\leq 1.5 \text{ mm}$ or $\leq 200 \text{ m/s}^2$ ; 7.5 h  | $\pm (0.03 \% R)$  |                                    |
| 4.38                             | -                                 | Electrostatic discharge (human body model)                  | IEC 61340-3-1 (1);<br>3 pos. + 3 neg. discharges<br>MMA 0204 HV AT: 6 kV<br>MMB 0207 HV AT: 8 kV                                     | $\pm (0.5 \% R)$   |                                    |
| 4.17                             | 58 (Td)                           | Solderability   | Solder bath method;<br>SnPb40; non-activated flux;<br>(215 $\pm$ 3) $^{\circ}\text{C}$ ; (3 $\pm$ 0.3) s                             | Good tinning ( $\geq 95 \%$ covered);<br>no visible damage               |                                    |
|                                  |                                   |   | Solder bath method;<br>SnAg3Cu0.5 or SnAg3.5;<br>non-activated flux;<br>(245 $\pm$ 5) $^{\circ}\text{C}$ ; (3 $\pm$ 0.3) s           | Good tinning ( $\geq 95 \%$ covered);<br>no visible damage               |                                    |
| 4.18                             | 58 (Td)                           | Resistance to soldering heat                                | Solder bath method;<br>(260 $\pm$ 5) $^{\circ}\text{C}$ ; (10 $\pm$ 1) s   | $\pm (0.05 \% R)$  | $\pm (0.25 \% R)$                  |
|                                  |                                   |   | Reflow method 2<br>(IR/forced gas convection);<br>(260 $\pm$ 5) $^{\circ}\text{C}$ ; (10 $\pm$ 1) s                                  | $\pm (0.05 \% R)$  | $\pm (0.1 \% R)$                   |
| 4.29                             | 45 (XA)                           | Component solvent resistance                                | Isopropyl alcohol; 50 $^{\circ}\text{C}$ ;<br>method 2   | No visible damage  |                                    |
| 4.30                             | 45 (XA)                           | Solvent resistance of marking                               | Isopropyl alcohol; 50 $^{\circ}\text{C}$ ;<br>method 1, toothbrush   | Marking legible; no visible damage                                       |                                    |
| 4.32                             | 21 (Ue <sub>3</sub> )             | Shear (adhesion)  | 45 N   | No visible damage  |                                    |
| 4.33                             | 21 (Ue <sub>1</sub> )             | Substrate bending   | Depth 2 mm, 3 times  | No visible damage, no open circuit in bent position<br>$\pm (0.05 \% R)$ |                                    |
| 4.7                              | -                                 | Voltage proof   | $U_{RMS} = U_{ins.}; 60 \text{ s}$   | No flashover or breakdown  |                                    |
| 4.35                             | -                                 | Flammability  | IEC 60695-11-5 (1),<br>needle flame test; 10 s   | No burning after 30 s  |                                    |

**Note**

(1) The quoted IEC standards are also released as EN standards with the same number and identical contents



**DIMENSIONS**


| DIMENSIONS AND MASS |                  |                 |                          |                     |            |           |
|---------------------|------------------|-----------------|--------------------------|---------------------|------------|-----------|
| TYPE / SIZE         | L (mm)           | D (mm)          | L <sub>1</sub> min. (mm) | D <sub>1</sub> (mm) | K (mm)     | MASS (mg) |
| MMA 0204 HV AT      | 3.6 + 0 / - 0.2  | 1.4 + 0 / - 0.1 | 1.8                      | D + 0 / - 0.15      | 0.75 ± 0.1 | 22        |
| MMB 0207 HV AT      | 5.8 + 0 / - 0.15 | 2.2 + 0 / - 0.2 | 3.2                      | D + 0 / - 0.2       | 1.15 ± 0.1 | 80        |

**Notes**

- Color code marking is applied according to IEC 60062 <sup>(1)</sup> in four bands (E24 series) or in five bands (E192 series). Each color band appears as a single solid line, voids are permissible if at least 2/3 of the band is visible from each radial angle of view. The last color band for tolerance is approximately 50 % wider than the other bands.
  - An interrupted violet band between the 3<sup>rd</sup> and 4<sup>th</sup> full band identifies the special high voltage type. An interrupted band between the 4<sup>th</sup> and 5<sup>th</sup> full band indicates the temperature coefficient (yellow = TC25).
- <sup>(1)</sup> The quoted IEC standards are also released as EN standards with the same number and identical contents.

**SOLDERING RECOMMENDATIONS**

For recommended solder pad dimensions please refer to [www.vishay.com/doc?28950](http://www.vishay.com/doc?28950).

For recommended soldering profiles please refer to [www.vishay.com/doc?31090](http://www.vishay.com/doc?31090).



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